

## **Vishay Siliconix**

# **Dual P-Channel 30-V (D-S) MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
-30	0.027 @ V <sub>GS</sub> = -10 V	-9.0		
	0.039 @ V <sub>GS</sub> = -4.5 V	-7.5		

#### **FEATURES**

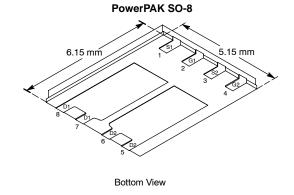


- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile

Pb-free Available

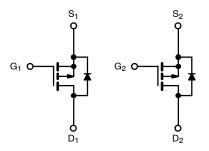
#### **APPLICATIONS**

- 3-4 Cell Li-Ion Battery Switch
- Bus Load Switch for Notebook/Desktop Computers



Ordering Information: Si7941DP-T1

Si7941DP-T1—E3 (Lead (Pb)-Free)



P-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)						
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	-30		٧	
Gate-Source Voltage		V <sub>GS</sub>	±20			
Continuous Drain Current (T,I = 150°C) <sup>a</sup>	T <sub>A</sub> = 25°C	l <sub>D</sub>	-9.0	-5.8	A	
Continuous Diam Current (1) = 150 C)-	T <sub>A</sub> = 70°C		-7.2	-4.7		
Pulsed Drain Current		I <sub>DM</sub>	-30		^	
continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	-2.9	-1.2		
Martine on Develop Distinctions	T <sub>A</sub> = 25°C	- P <sub>D</sub>	3.5	1.4	W	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70°C		2.2	0.9		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C	
Soldering Recommendations (Peak Temperature)b, c			260			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
	t ≤ 10 sec	R <sub>thJA</sub>	26	35	°C/W		
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		60	85			
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	2.2	2.7	1		

#### Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. See Solder Profile (http://www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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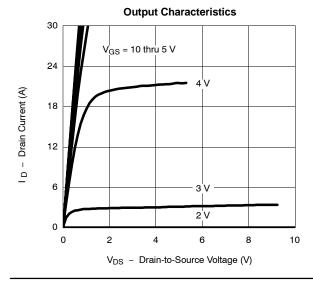


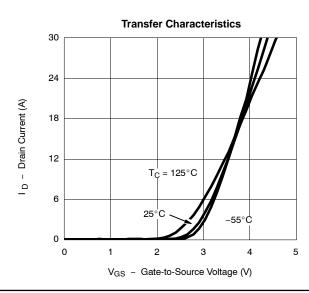
SPECIFICATIONS (T <sub>J</sub> = 25°C UNLESS OTHERWISE NOTED)							
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static			•		1	•	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1.0		-3.0	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = $\pm$ 20 V			± 100	nA	
- 0. Wh. B. 0.	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	-1		-1		
Zero Gate Voltage Drain Current		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70^{\circ}\text{C}$			-10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	-30			Α	
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	$V_{GS} = -10 \text{ V}, I_D = -9 \text{ A}$		0.022	0.027		
Drain-Source On-State Resistance <sup>4</sup>		$V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$		0.032	0.039	Ω	
Forward Transconductance <sup>a</sup>	9fs	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -2.5 A		14		S	
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_S = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$		-0.8	-1.2	V	
Dynamic <sup>b</sup>							
Total Gate Charge	Qg			42	51	nC	
Gate-Source Charge	$Q_{gs}$	$V_{DS}$ = -15 V, $V_{GS}$ = -10 V, $I_D$ = -9 A		8.5			
Gate-Drain Charge	$Q_{\mathrm{gd}}$			7.5		1	
Gate Resistance	$R_g$			2.9		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -15 V, R <sub>L</sub> = 15 Ω		18	30		
Rise Time	t <sub>r</sub>			29	45	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong -1$ A, $V_{GEN} = -10$ V, $R_g = 6 \Omega$		65	100		
Fall Time	t <sub>f</sub>			27	41		
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	$I_F = -2.9 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		50	90		

- $\begin{array}{ll} \mbox{Notes} \\ \mbox{a.} & \mbox{Pulse test; pulse width} \leq 300 \ \mu \mbox{s, duty cycle} \leq 2 \%. \\ \mbox{b.} & \mbox{Guaranteed by design, not subject to production testing.} \end{array}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)





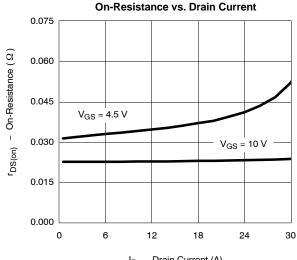


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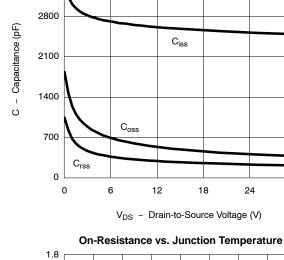


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## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

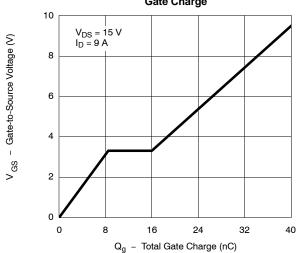




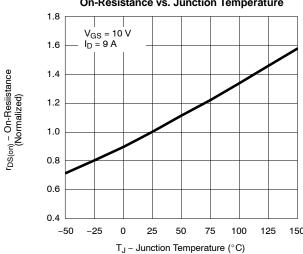


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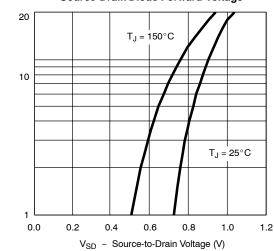
**Gate Charge** 



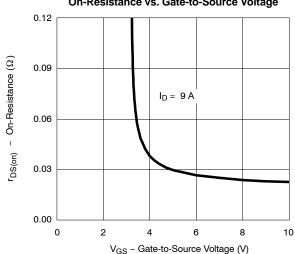
Capacitance



Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

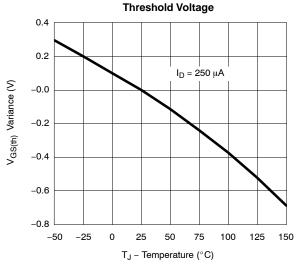


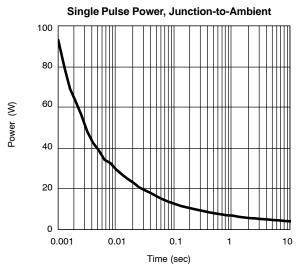
Source Current (A)

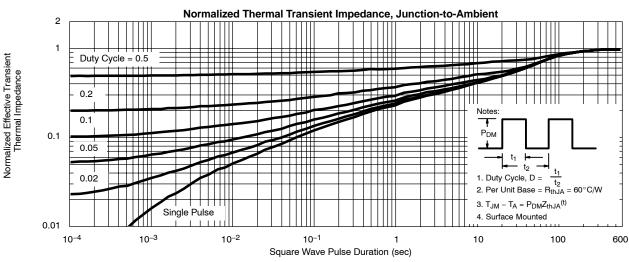
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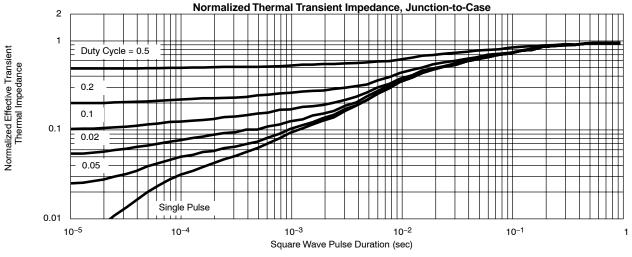


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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?71630">http://www.vishay.com/ppg?71630</a>.



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